Switching (200V, 15A)

RDN150N20

Features

- 1) Low on-resistance.
- www.DataSheet4U.co2) Low input capacitance.
 - 3) Exellent resistance to damage from static electricity.

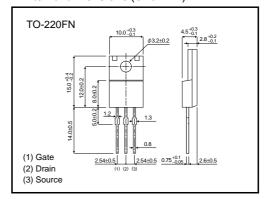
Application

Switching

●Structure

Silicon N-channel MOS FET

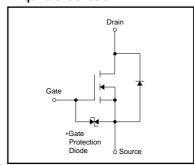
●External dimensions (Unit : mm)



●Absolute maximum ratings (Ta=25°C)

Parameter		Symbol	Limits	Unit			
Drain-Source Voltage		VDSS	200	V			
Gate-Source Voltage		V _{GSS}	±30	V			
Drain Current	Continuous	I _D	15	Α			
	Pulsed	I _{DP} *1	45	Α			
Reverse Drain Current	Continuous	I_{DR}	15	Α			
	Pulsed	I _{DRP} *1	45	Α			
Avalanche Current		I _{AS} *2	15	Α			
Avalanche Energy		E _{AS} *2	210	mJ			
Total Power Dissipation (Tc=25°C)		P _D	40	W			
Channel Temperature		T _{ch}	150	°C			
Storage Temperature		Tstg	-55 to +150	°C			

●Equivalent circuit



*A protection diode is included between the gate and the source terminals to protect the diode against static electricity when the product is in use. Use the protection circuit when the fixed voltages are exceeded.

^{*1} Pw ≤ 10μs, Duty cycle ≤ 1% *2 L≒ 4.5mH, Vpp=50V, Rg=25Ω, 1Pulse, Tch=25°C

●Electrical characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Gate-Source Leakage	Igss	_	_	±10	μА	Vgs=±30V, Vps=0V
Drain-Source Breakdown Voltage	V(BR) DSS	200	_	_	V	I _D =250μA, V _G s=0V
Zero Gate Voltage Drain Current	IDSS	_	_	25	μΑ	Vps=200V, Vgs=0V
Gate Threshold Voltage	VGS (th)	2.0	_	4.0	V	VDS=10V, ID=1mA
Static Drain-Source On-State Resistance	RDS (on)	_	0.12	0.16	Ω	In=7.5A, Vgs=10V
Forward Transfer Admittance	Yfs	4.0	6.6	_	S	Vps=10V, Ip=7.5A
Input Capacitance	Ciss	_	1224	_	pF	Vps=10V
Output Capacitance	Coss	_	443	_	pF	Vgs=0V
Reverse Transfer Capacitance	Crss	_	154	_	pF	f=1MHz
Turn-On Delay Time	td (on)	_	17	_	ns	ID=7.5A, VDD≒100V
Rise Time	tr	_	37	_	ns	Vgs=10V
Turn-Off Delay Time	td (off)	_	62	_	ns	RL=13Ω
Fall Time	t f	_	31	_	ns	Rgs=10Ω
Reverse Recovery Time	trr	_	158	_	ns	Idr=15A, Vgs=0V
Reverse Recovery Charge	Qrr	_	0.79	_	μC	di / dt=100A / μs
Total Gate Charge	Qg		32	_	nC	Vpd=100V,Vgs=10V,Id=15A

•Electrical characteristic curves

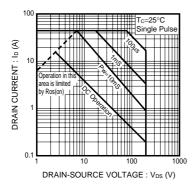


Fig.1 Maximun Safe Operating Area

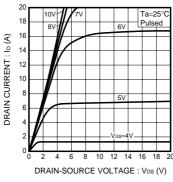


Fig.2 Typical Output Characteristics

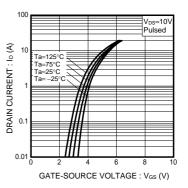


Fig.3 Typical Transfer Characteristics

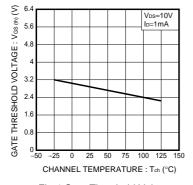


Fig.4 Gate Threshold Voltage vs. Channel Temperature

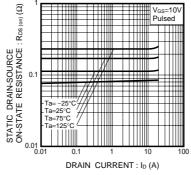


Fig.5 Static Drain-Source On-State Resistance vs. Drain Current

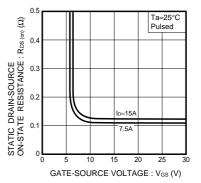


Fig.6 Static Drain-Source On-State Resistance vs. Gate-Source Voltage



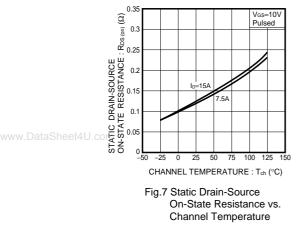


Fig.7 Static Drain-Source On-State Resistance vs. **Channel Temperature**

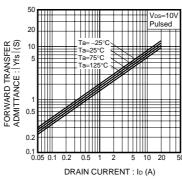


Fig.8 Forward Transfer Admittance vs. Drain Current

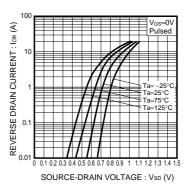


Fig.9 Reverse Drain Current vs. Source-Drain Voltage

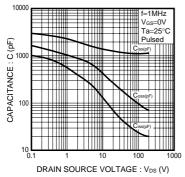


Fig.10 Typical Capacitance vs. Drain-Source Voltage

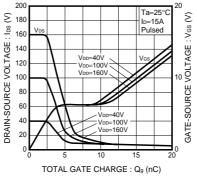


Fig.11 Dynamic Input Characteristics

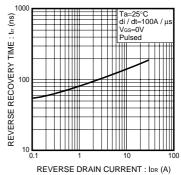


Fig.12 Reverse Recovery Time vs. Reverse Drain Current

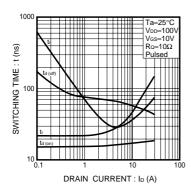


Fig.13 Switching Characteristcs

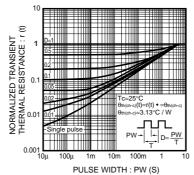


Fig.14 Normalized Transient Thermal Resistance vs. Pulse Width

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Appendix1-Rev1.0